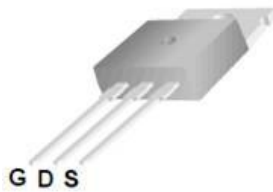


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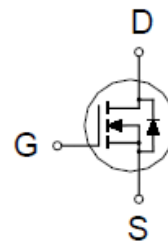
N-Channel Enhancement Mode MOSFET

PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D^2
100V	6.5mΩ @ $V_{GS} = 10V$	120A



TO-220



ABSOLUTE MAXIMUM RATINGS ($T_A = 25\text{ °C}$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNITS
Drain-Source Voltage		V_{DS}	100	V
Gate-Source Voltage		V_{GS}	±20	
Continuous Drain Current ²	$T_C = 25\text{ °C}$	I_D	120	A
	$T_C = 100\text{ °C}$		76	
Pulsed Drain Current ¹		I_{DM}	375	
Avalanche Current		I_{AS}	39	
Avalanche Energy	$L = 1\text{mH}$	E_{AS}	770	mJ
Power Dissipation	$T_C = 25\text{ °C}$	P_D	208	W
	$T_C = 100\text{ °C}$		83	
Operating Junction & Storage Temperature Range		T_J, T_{STG}	-55 to 150	°C

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Case	$R_{\theta JC}$		0.6	°C / W
Junction-to-Ambient	$R_{\theta JA}$		62.5	

¹Pulse width limited by maximum junction temperature.

²Package limitation current is 110A.

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ELECTRICAL CHARACTERISTICS (T_J = 25 °C, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNITS		
			MIN	TYP	MAX			
STATIC								
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 250μA	100			V		
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250μA	1.3	1.8	2.3			
Gate-Body Leakage	I _{GSS}	V _{DS} = 0V, V _{GS} = ±20V			±100	nA		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 80V, V _{GS} = 0V			1	μA		
		V _{DS} = 80V, V _{GS} = 0V, T _J = 125 °C			10			
Drain-Source On-State Resistance ¹	R _{DS(ON)}	V _{GS} = 4.5V, I _D = 20A		5.8	8	mΩ		
		V _{GS} = 10V, I _D = 20A		5.3	6.5			
Forward Transconductance ¹	g _{fs}	V _{DS} = 10V, I _D = 20A		140		S		
DYNAMIC								
Input Capacitance	C _{iss}	V _{GS} = 0V, V _{DS} = 25V, f = 1MHz		6188		pF		
Output Capacitance	C _{oss}			747				
Reverse Transfer Capacitance	C _{rss}			233				
Gate Resistance	R _g	V _{GS} = 0V, V _{DS} = 0V, f = 1MHz		1.26		Ω		
Total Gate Charge ²	Q _g (V _{GS} =10V)	V _{DS} = 50V, I _D = 20A		121		nC		
	Q _g (V _{GS} =4.5V)			64.2				
Gate-Source Charge ²	Q _{gs}			15.8				
Gate-Drain Charge ²	Q _{gd}			30				
Turn-On Delay Time ²	t _{d(on)}		V _{DD} = 50V, I _D ≅ 20A, V _{GS} = 10V, R _{GEN} = 6Ω		20			nS
Rise Time ²	t _r				60			
Turn-Off Delay Time ²	t _{d(off)}			55				
Fall Time ²	t _f			57				
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T_J = 25 °C)								
Continuous Current ³	I _S				120	A		
Forward Voltage ¹	V _{SD}	I _F = 20A, V _{GS} = 0V			1.2	V		
Reverse Recovery Time	t _{rr}	I _F = 20A, dI _S /dt = 100A / μS			58	nS		
Reverse Recovery Charge	Q _{rr}				136	nC		

¹Pulse test : Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.

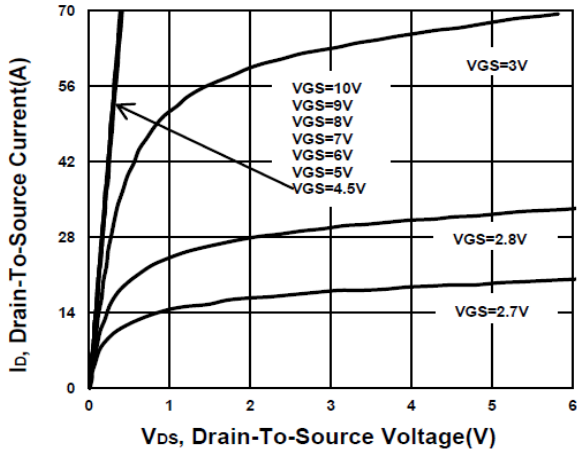
²Independent of operating temperature.

³Package limitation current is 110A.

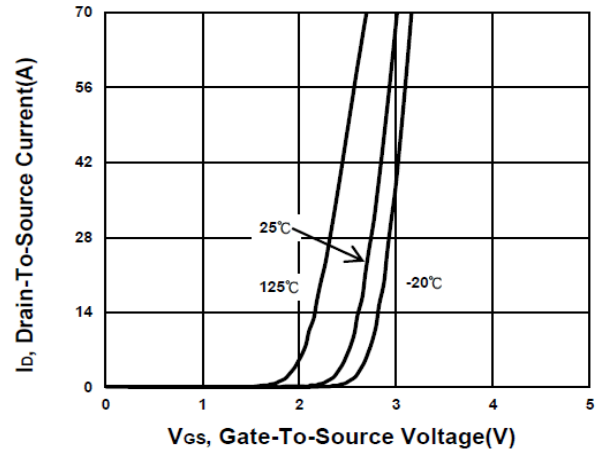
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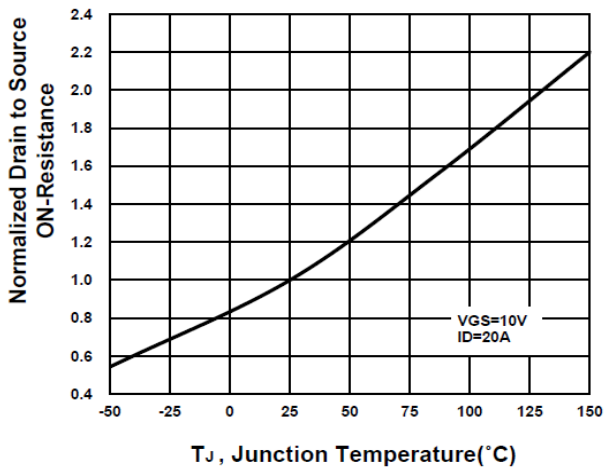
Output Characteristics



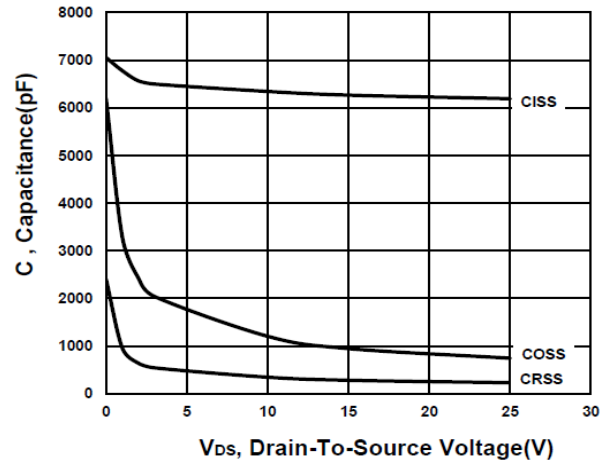
Transfer Characteristics



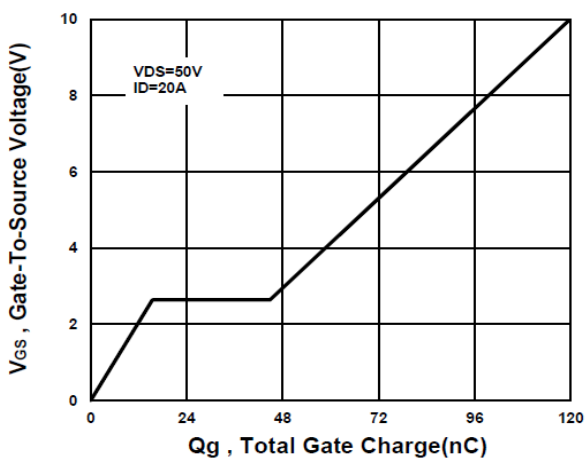
On-Resistance VS Temperature



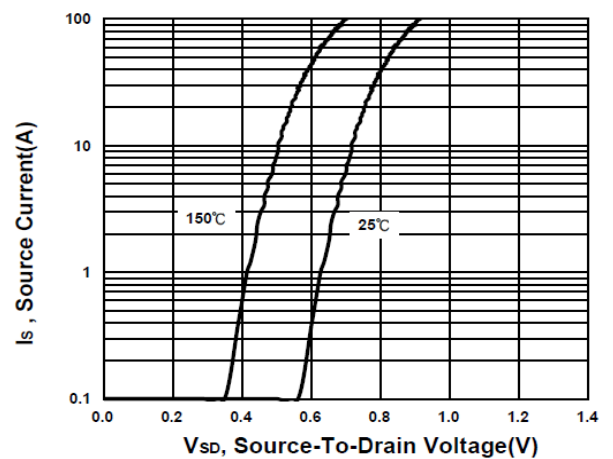
Capacitance Characteristic



Gate charge Characteristics



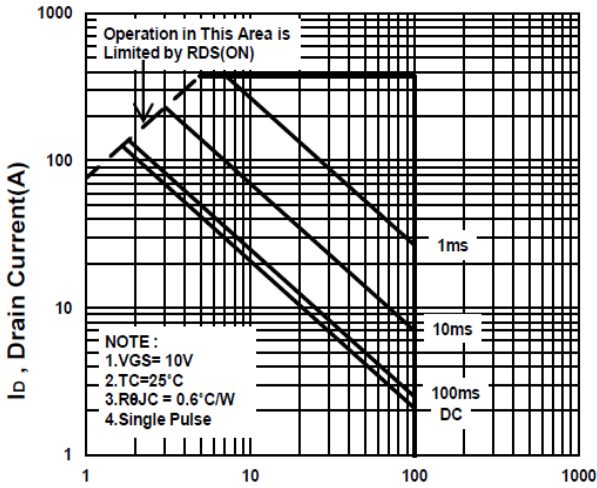
Source-Drain Diode Forward Voltage



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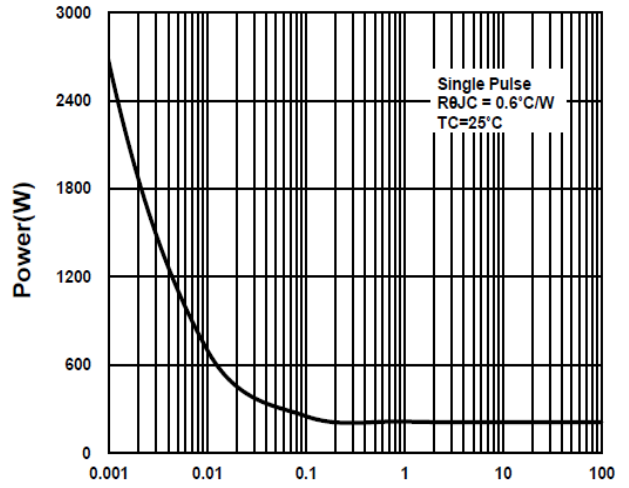
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Safe Operating Area



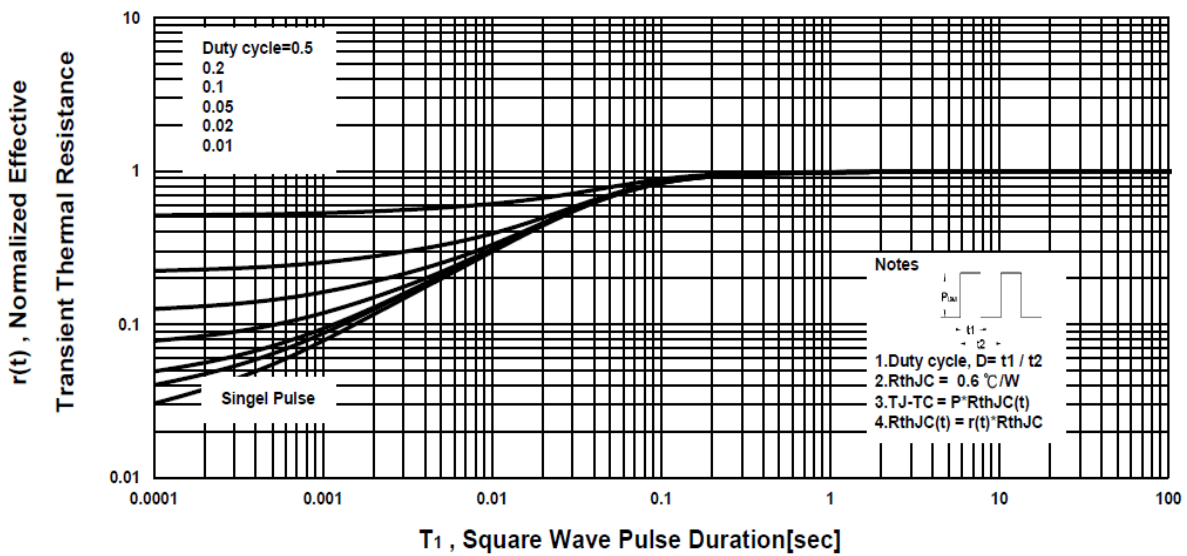
V_{ds}, Drain-To-Source Voltage(V)

Single Pulse Maximum Power Dissipation



Single Pulse Time(s)

Transient Thermal Response Curve



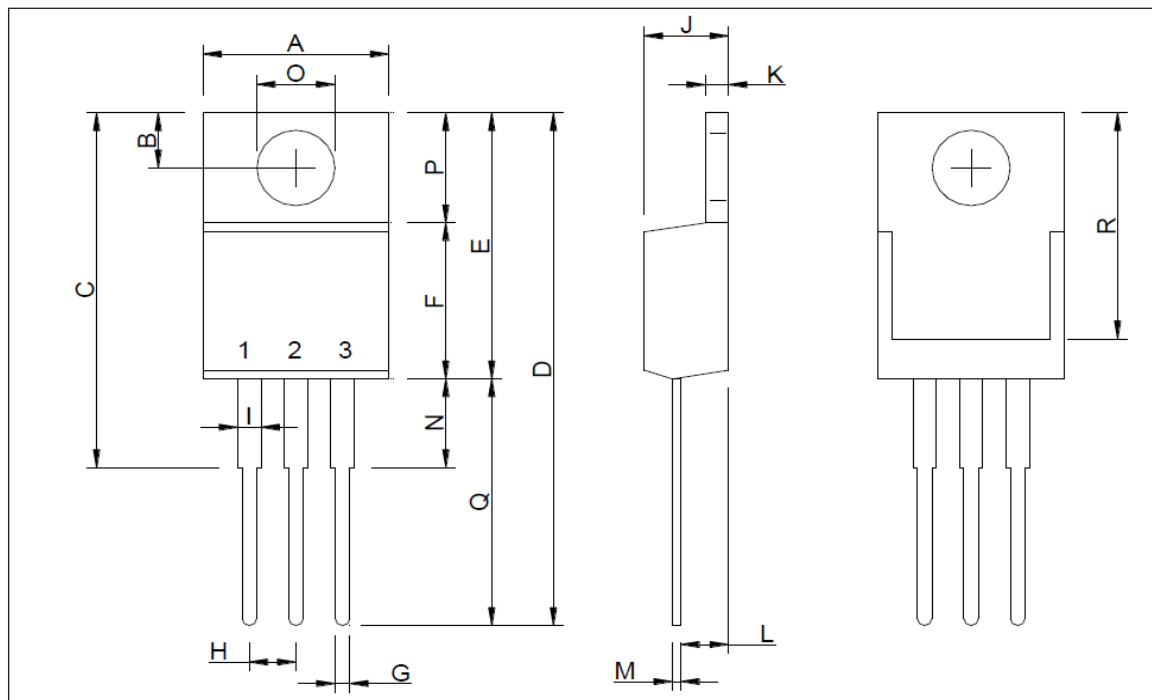
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Package Dimension

TO-220 (3-Lead) MECHANICAL DATA

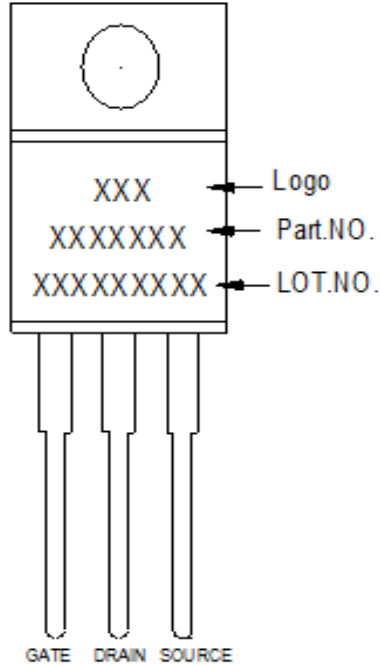
Dimension	mm			Dimension	mm		
	Min.	Typ.	Max.		Min.	Typ.	Max.
A	9.65		11.5	J	3.55		4.83
B		2.54		K	1.11		1.45
C	18.1		22.86	L	1.89		3.09
D	26.9		31.24	M	0.34		0.61
E	14.32		16.51	N	2.6		4.06
F	8.38		9.3	O		3.7	
G	0.38		1.02	P	5.84		6.85
H	2.04	2.54	3.04	Q	12.5		14.73
I	1.14		1.8	R	11.3		13.31



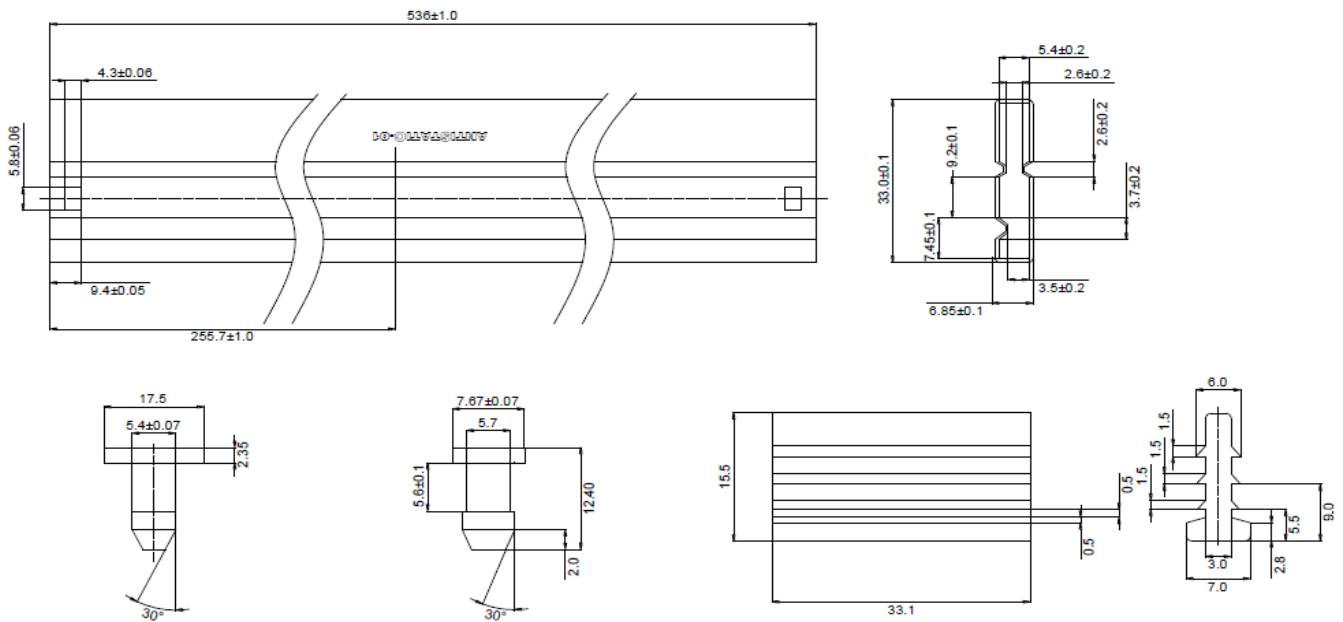
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A. Marking Information



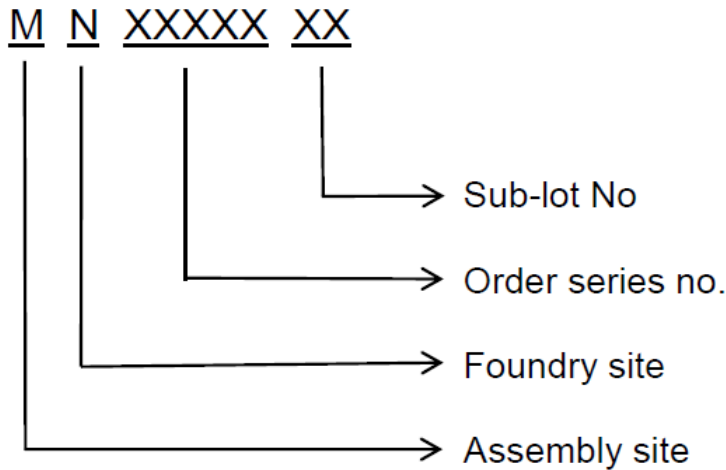
B. Tape & Reel Information: 50pcs/Tube



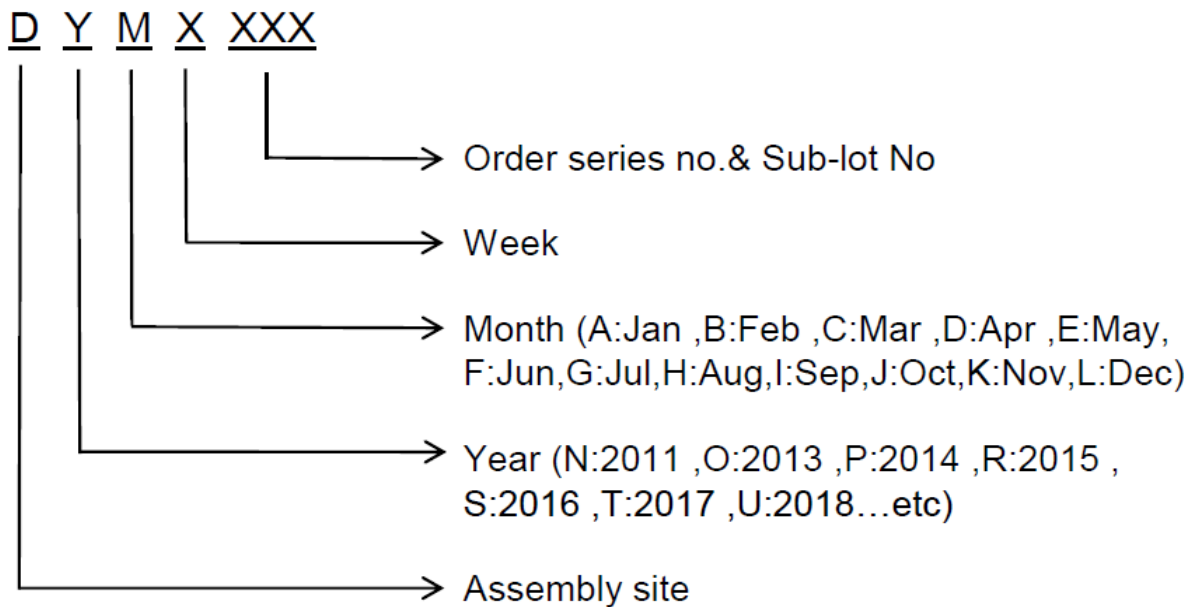
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C. Lot No.&Date Code rule

1.Lot No.



2.Date Code





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D.Label rule

标签内容(Label content)



1	Label Size	30 * 90 mm
2	Font style	Times New Roman or Arial (或可区分英文”0”和数字”0”，”G和”Q”的字型即可)
3	U-NIKC	Height: 4 mm
4	Package	Height: 2 mm
5	Date	Height: 2 mm Shipping date: YYYY/MM/DD, ex. 2008/09/12
6	Device	Height: 3 mm (Max: 16 Digit)
7	Lot	Height: 3 mm (Max: 9 Digit) Sub lot
8	D/C	Height: 3 mm (Max: 7 Digit)
9	QTY	Height: 3 mm (Max: 6 Digit) Thousand mark is no needed
10	RoHS label	 long axis: 12 mm minor axis: 6 mm bottom color: White Font color: Black Font style: Arial
11	Halogen Free label	 Diameter: 10 mm bottom color: Green Font color: Black Font style: Arial
12	Scan information	Device / Lot / D/C / QTY , Insert “ / “ between every parts. for example: P3055LDG/G12345601/GGG2301/2000 DPI (Dots per inch): Over 300 dpi Code : Code 128 Height: 6 mm at least